

CGHV31500F

500 W, 2700 - 3100 MHz, 50-Ohm Input/Output
Matched, GaN HEMT for S-Band Radar Systems

Description

Wolfspeed's CGHV31500F is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV31500F ideal for 2.7 - 3.1 GHz S-Band radar amplifier applications. The transistor is supplied in a ceramic/metal flange package, type 440226.



Package Types: 440226
PN's: CGHV31500F

Features

- 2.7 - 3.1 GHz operation
- 650 W typical output power
- 12 dB power gain
- 65% typical drain efficiency
- 50 Ohm internally matched
- <0.3 dB pulsed amplitude droop

Typical Performance Over 2.7-3.1 GHz ($T_c = 25^\circ\text{C}$) of Demonstration Amplifier

Parameter	2.7 GHz	2.9 GHz	3.1 GHz	Units
Output Power	630	725	630	W
Gain	12.1	12.5	11.8	dB
Drain Efficiency	70	68	58	%

Note:

Measured in the CGHV31500F-AMP application circuit, under 100 μs pulse width, 10% duty cycle, $P_{\text{IN}} = 46 \text{ dBm}$.

Absolute Maximum Ratings (Not Simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Pulse Width	PW	500	μs	
Duty Cycle	DC	10	%	
Drain-Source Voltage	V_{DSS}	150	Volts	25 °C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25 °C
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225	°C	
Maximum Forward Gate Current	I_{GMAX}	80	mA	25 °C
Maximum Drain Current ¹	I_{DMAX}	24	A	25 °C
Soldering Temperature ²	T_S	245	°C	
Screw Torque	τ	40	in-oz	
Pulsed Thermal Resistance, Junction to Case	$R_{θJC}$	0.22	°C/W	100 μsec, 10%, 85 °C, $P_{DISS} = 376$ W
Case Operating Temperature	T_c	-40, +125	°C	

Notes:

¹ Current limit for long term, reliable operation.

² Refer to the Application Note on soldering at www.wolfspeed.com/rf/document-library

Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics ¹ ($T_c = 25$ °C)						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10$ V, $I_D = 83.6$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V_{DC}	$V_{DS} = 50$ V, $I_D = 0.5$ A
Saturated Drain Current ²	I_{DS}	62.7	75.5	-	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	V_{BR}	125	-	-	V_{DC}	$V_{GS} = -8$ V, $I_D = 83.6$ mA
RF Characteristics ³ ($T_c = 25$ °C, $F_0 = 2.7$ - 3.1 GHz Unless Otherwise Noted)						
Output Power at 2.7 GHz	P_{OUT1}	473	630	-	W	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Output Power at 2.9 GHz	P_{OUT2}	555	725	-	W	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Output Power at 3.1 GHz	P_{OUT3}	473	630	-	W	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Gain at 2.7 GHz	G_{P1}	-	12.1	-	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Gain at 2.9 GHz	G_{P2}	-	12.5	-	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Gain at 3.1 GHz	G_{P3}	-	11.8	-	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Drain Efficiency at 2.7 GHz	D_{E1}	57	68	-	%	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Drain Efficiency at 2.9 GHz	D_{E2}	54	67	-	%	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Drain Efficiency at 3.1 GHz	D_{E3}	50	62	-	%	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Small Signal Gain	$S21$	11.25	14.5	-	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 10$ dBm
Input Return Loss	$S11$	-	-15	-5.25	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 10$ dBm
Output Return Loss	$S22$	-	-5	-3	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 10$ dBm
Amplitude Droop	D	-	-0.3	-	dB	$V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm
Output Stress Match	VSWR	-	5.1	-	Ψ	No Damage at All Phase Angles, $V_{DD} = 50$ V, $I_{DQ} = 500$ mA, $P_{IN} = 46$ dBm Pulsed

Notes:

¹ Measured on wafer prior to packaging.

² Scaled from PCM data.

³ Measured in CGHV31500F-AMP. Pulse width = 100 μs, duty cycle = 10%.

Typical Performance

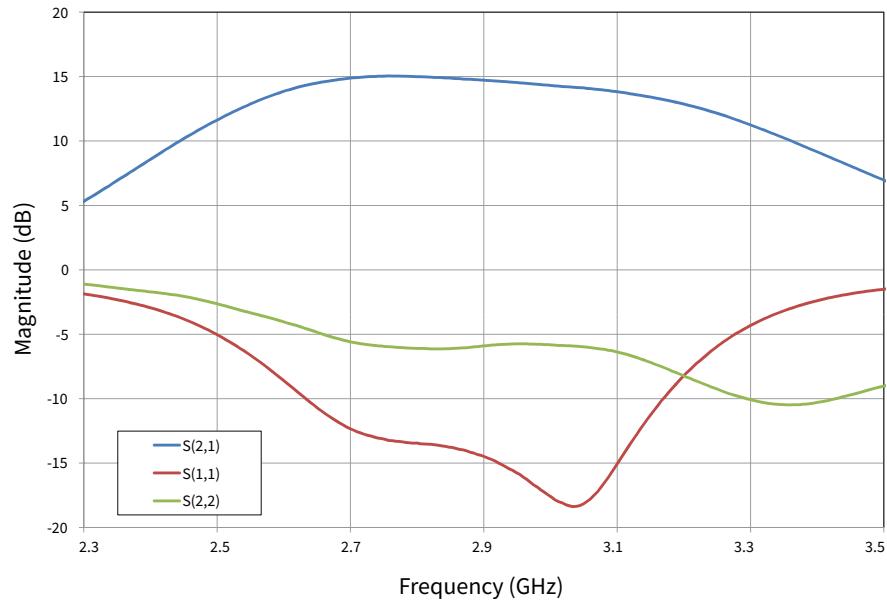


Figure 1. CGHV31500F S-Parameters $V_{DD} = 50$ V, $I_{DQ} = 0.5$ A

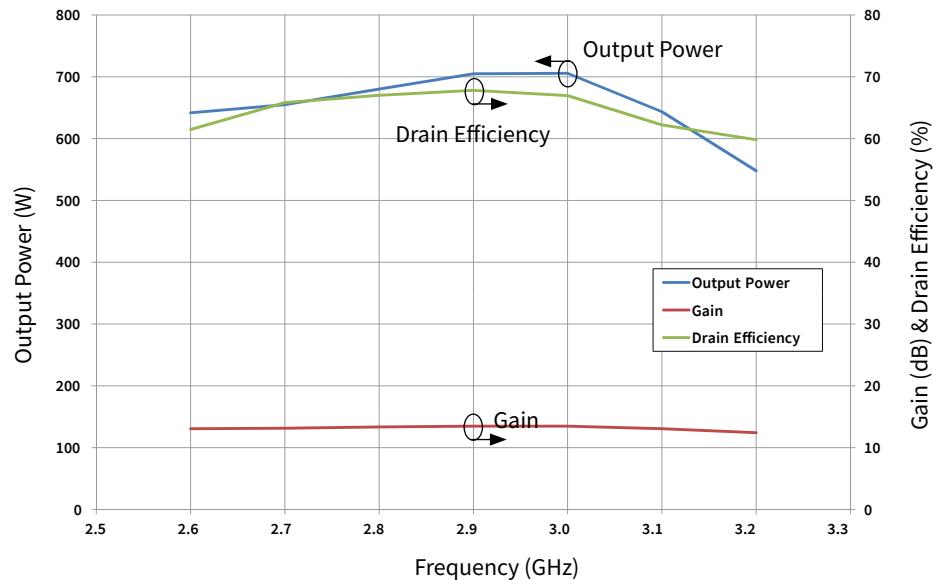
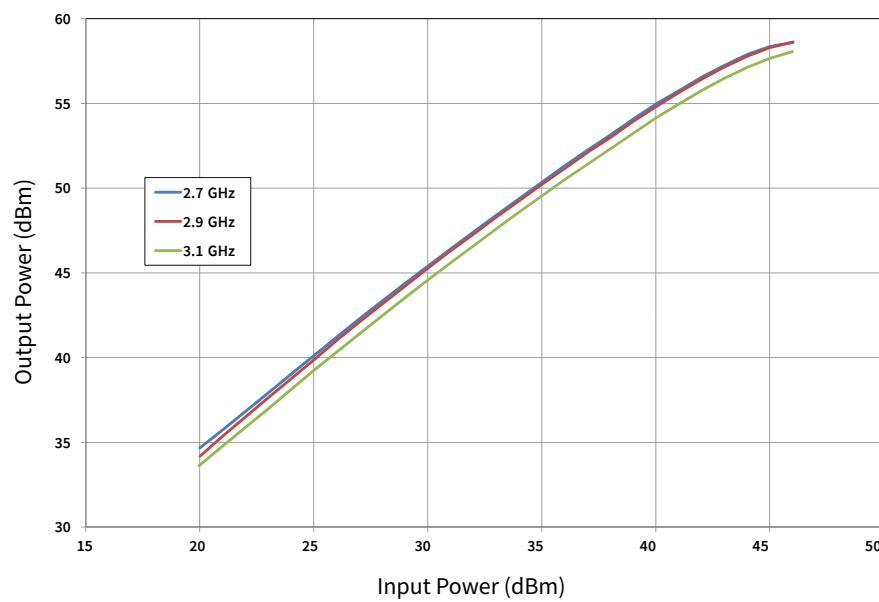
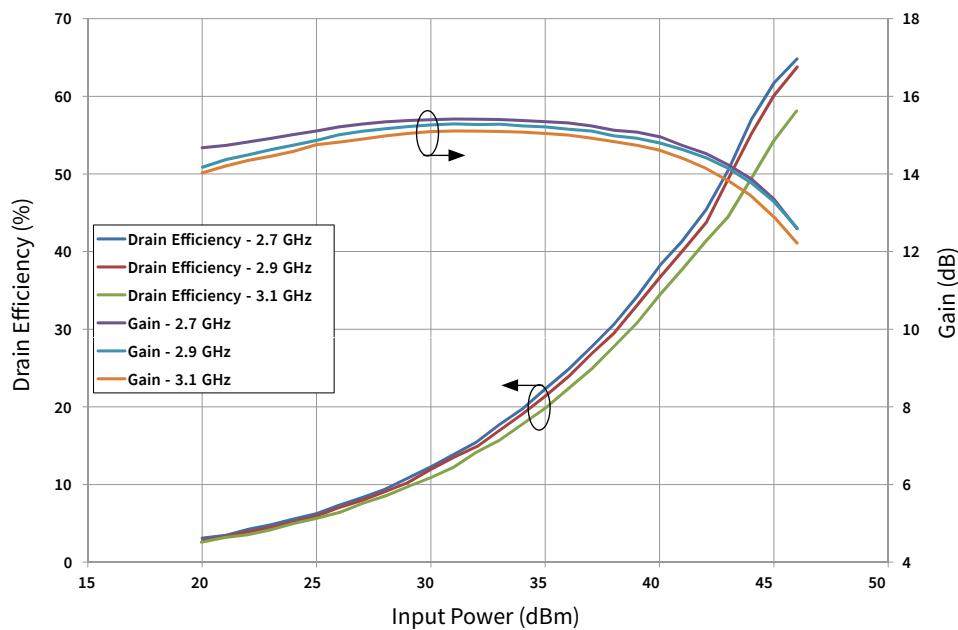


Figure 2. CGHV31500F Output Power and Drain Efficiency vs Frequency
 $V_{DD} = 50$ V, $I_{DQ} = 0.5$ A, $P_{IN} = 46$ dBm, Pulse Width = 100 μ s, Duty Cycle = 10%, $T_{CASE} = 25$ °C

Typical Performance

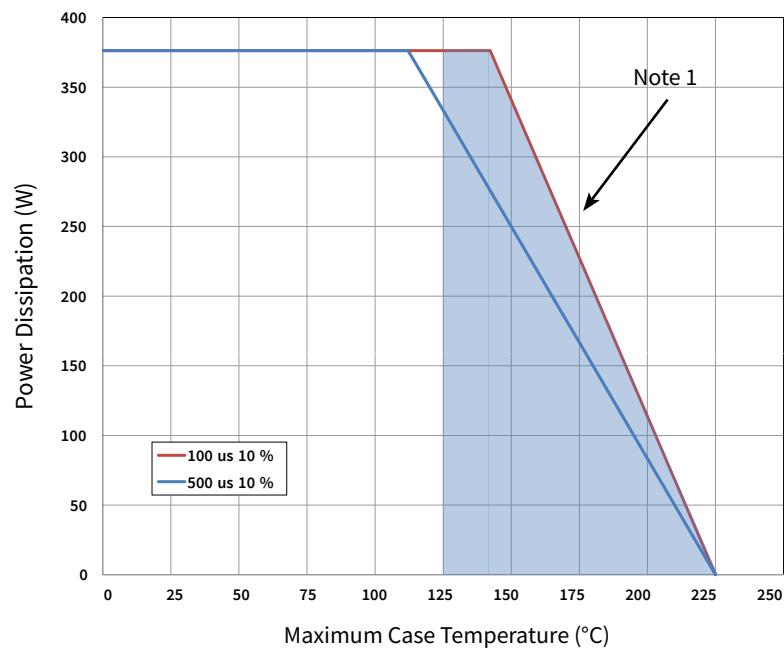




CGHV31500F-AMP Application Circuit Bill of Materials

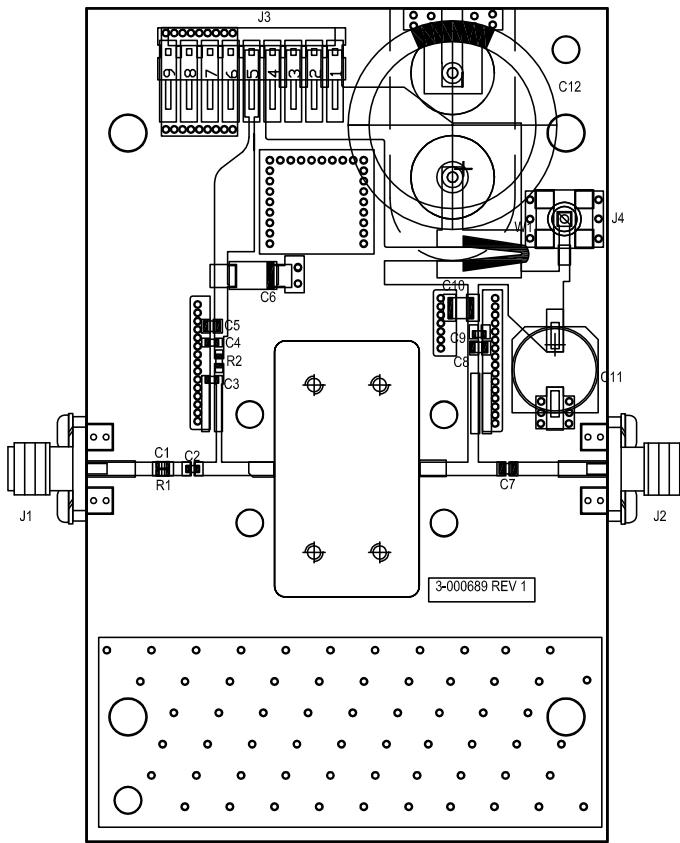
Designator	Description	Qty
R1	RES, 511, OHM, +/- 1%, 1/16 W, 0603	1
R2	RES, 5.1, OHM, +/- 1%, 1/16 W, 0603	1
C1	CAP, 6.8 pF, +/-0.25%, 250 V, 0603	1
C2, C7, C8	CAP, 10.0 pF, +/-1%, 250 V, 0805	3
C3	CAP, 10.0 pF, +/-5%, 250 V, 0603	1
C4, C9	CAP, 470 pF, 5%, 100 V, 0603, X	2
C5	CAP, 33000 pF, 0805, 100 V, X7R	1
C6	CAP, 10 uF 16 V TANTALUM	1
C10	CAP, 1.0 uF, 100 V, 10%, X7R, 1210	1
C11	CAP, 33 uF, 20%, G CASE	1
C12	CAP, 3300 uF, +/-20%, 100 V, ELECTROLYTIC	1
J1, J2	CONN, SMA, PANEL MOUNT JACK, FL	2
J3	HEADER, RT>PLZ, 0.1 CEN LK 9 POS	1
J4	CONNECTOR; SMB, Straight, JACK, SMD	1
W1	CABLE, 18 AWG, 4.2	1
-	PCB, RO4350, 2.5 X 4.0 X 0.030	1
Q1	CGHV31500F	1

CGHV31500F Power Dissipation De-rating Curve

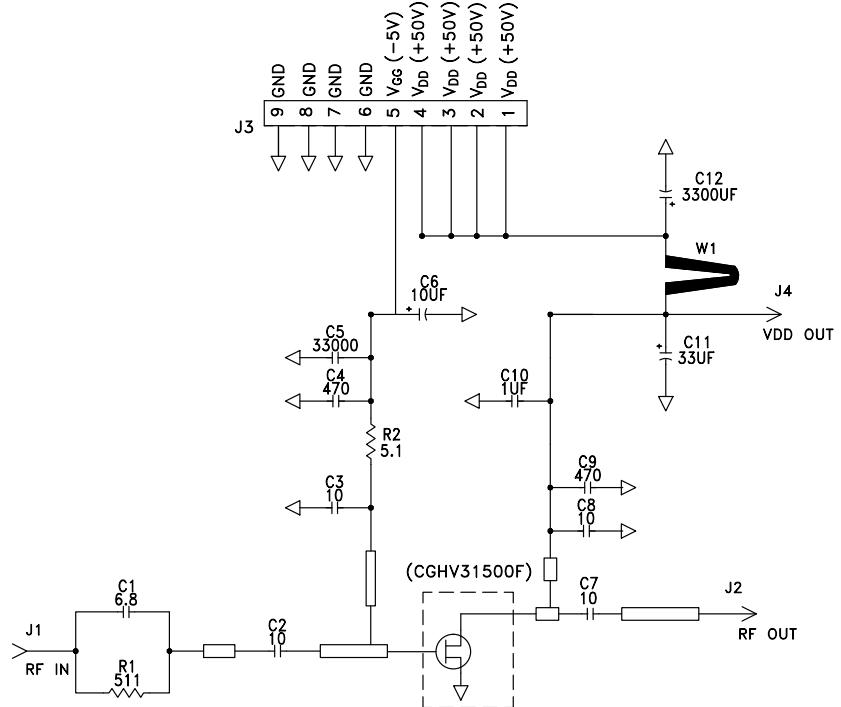


Note 1. Area exceeds maximum case operating temperature (See page 2).

CGHV31500F-AMP Application Circuit Outline



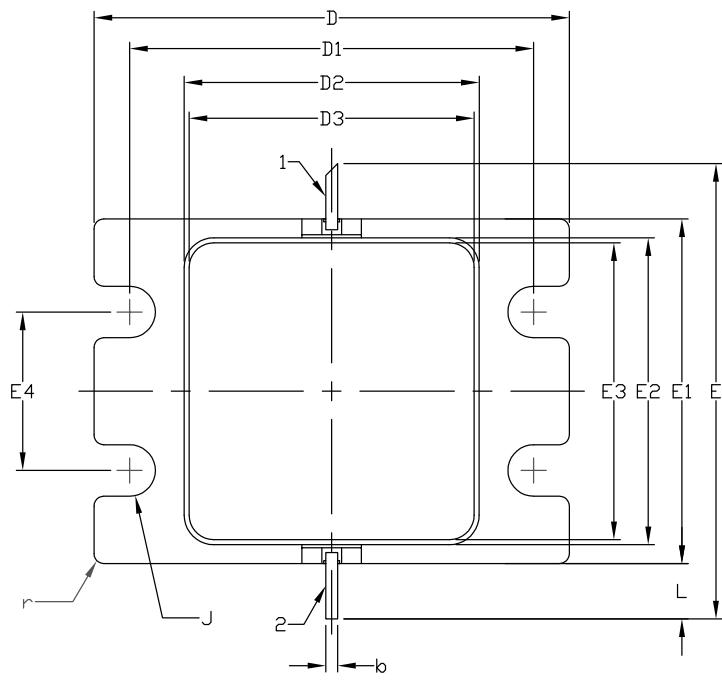
CGHV31500F-AMP Application Circuit Schematic



Product Dimensions CGHV31500F (Package Type – 440226)

NOTES: (UNLESS OTHERWISE SPECIFIED)

1. INTERPRET DRAWING IN ACCORDANCE WITH ANSI Y14.5M-2009
2. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF .020 BEYOND EDGE OF LID
3. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF .008 IN ANY DIRECTION
4. ALL PLATED SURFACES ARE GOLD OVER NICKEL



1. GATE
2. DRAIN

DIM	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.185	0.201	4.70	5.11	
A1	0.088	0.100	2.24	2.54	2x
A2	0.049	0.061	1.24	1.55	
b	0.022	0.026	0.56	0.66	2x
c	0.003	0.006	0.08	0.15	
D	0.935	0.955	23.75	24.26	
D1	0.797	0.809	20.24	20.55	2x
D2	0.581	0.593	14.76	15.06	
D3	0.565	0.571	14.35	14.50	
E	0.906		23.01		REF
E1	0.679	0.691	17.25	17.55	
E2	0.604	0.616	15.34	15.65	
E3	0.588	0.594	14.93	15.09	
E4	0.309	0.321	7.85	8.15	2x
J	Ø0.097	Ø0.107	Ø2.46	Ø2.72	4x
L	0.090	0.130	2.29	3.30	2x
r	0.02	TYP	0.51	TYP	12x



Part Number System

CGHV31500F



Table 1.

Parameter	Value	Units
Upper Frequency ¹	3.1	GHz
Power Output	500	W
Package	Flange	-

Note:

¹ Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Parameter	Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1 A = 10.0 GHz 2 H = 27.0 GHz



Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV31500F	GaN HEMT	Each	
CGHV31500F-AMP	Test Board with GaN HEMT Installed	Each	

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